

C0402C151K1GACTU

Specifications

Insulation Resistance

Aliases (C0402C151K1GAC7867) SMD Comm COG, Ceramic, 150 pF, 10%, 100 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0402, 0.3 mm



General Information	
Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.06 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
Т	0.5mm +/-0.05mm
S	0.3mm MIN
В	0.3mm +/-0.1mm

	Capacitance	150 pF
	Measurement Condition	1 MHz 1.0Vrms
	Tolerance	10%
	Voltage DC	100 VDC
	Dielectric Withstanding Voltage	250 VDC
	Temperature Range	-55/+125°C
ı	Temp. Coefficient	COG
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour

100 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	10000

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